

# **Data sheet**

SAW Rx filter
M2M
LTE band 72

Part number: B8372

Ordering code: B39461B8372P810

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Please read **Cautions and warnings** and **Important notes** at the end of this document.

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#### 1 Application

- Low-loss SAW Rx filter for LTE Band 72 systems
- High out-of-band rejection
- Single-ended to balanced conversion
- Usable pass band: 5 MHz
- Rx = Downlink = 461 MHz 466 MHz

#### 2 Features

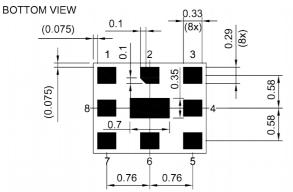
- Package size 2.0±0.1 mm × 1.6±0.1 mm
- Package height 0.47 mm (max.)
- Approximate weight 5 mg
- RoHS compatible
- Package for Surface Mount Technology (SMT)
- Ni/Au-plated terminals
- Electrostatic Sensitive Device (ESD)
- Moisture Sensitivity Level 3 (MSL3)



Figure 1: Picture of component with example of product marking.

# 3 Package

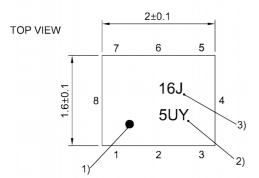
**Europe GmbH** 



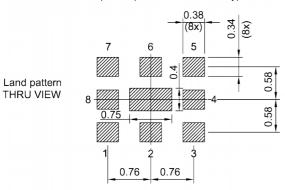
Pad and pitch tolerance ±0.05

#### SIDE VIEW





- 1) Marking for pad number 1
- 2) Example of encoded lot number
- 3) Example of encoded filter type number



Landing pad tolerance -0.02

**Figure 2:** Drawing of package with package height A = 0.47 mm (max.). See Sec. Package information (p. 18).

# 4 Pin configuration

■ 1 Input

■ 3, 4 Output balanced

■ 2, 5, 6, 7, Ground

8, 9



# 5 Matching circuit

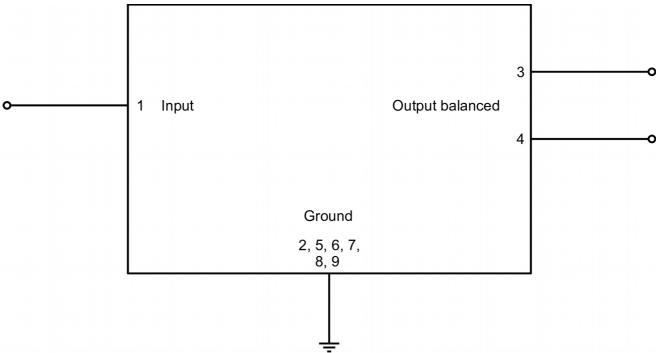


Figure 3: Schematic of matching circuit. No external matching components required.



# 6 Characteristics

**Europe GmbH** 

Temperature range for specification  $T_{\text{SPEC}} = -30 \,^{\circ}\text{C} \dots +85 \,^{\circ}\text{C}$ 

Input terminating impedance  $Z_{\rm IN} = 50~\Omega$  Output terminating impedance  $Z_{\rm OUT} = 100~\Omega$ 

Characteristics				$\begin{array}{c} \text{min.} \\ \text{for } T_{\text{SPEC}} \end{array}$	<b>typ.</b> @ +25 °C	$\begin{array}{c} \text{max.} \\ \text{for } T_{\text{\tiny SPEC}} \end{array}$	
Center frequency			f <sub>C</sub>	_	463.5	_	MHz
Maximum insertion attenuation			$\boldsymbol{\alpha}_{\text{max}}$				
	461 466	MHz		_	1.8	2.6	dB
Amplitude ripple (p-p)			Δα				
	461 466	MHz		_	0.5	1.3	dB
Maximum VSWR			$VSWR_{max}$				
@ input port	461 466	MHz		_	1.6	2.0	
@ output port	461 466	MHz		_	1.7	2.0	
Minimum common-mode rejection ratio			$CMRR_{\mathrm{min}}$				
	461 466	MHz		25	30	_	dB
Minimum attenuation			$\boldsymbol{\alpha}_{\text{min}}$				
	50 451	MHz		45	58	_	dB
	451 456	MHz		45	52	_	dB
	475 480	MHz		32	39	_	dB
	481 4000	MHz		40	47	_	dB
	4000 6000	MHz		45	59	_	dB



#### 7 **Maximum ratings**

**Europe GmbH** 

Operable temperature	T <sub>OP</sub> = −40 °C +85 °C	
Storage temperature	T <sub>STG</sub> <sup>1)</sup> = −40 °C +85 °C	
DC voltage	$ V_{DC} ^{2)} = 0 V$	
ESD voltage		
	$V_{\rm ESD}^{3)} = 150 \text{ V}$	Machine model.
	$V_{\rm ESD}^{4)} = 250 \text{ V}$	Human body model.
Input power @ input port: 461 466 MHz	$P_{IN} = 26 \text{ dBm}^{5), 6}$	5 MHz LTE downlink signal (25 RB) for 5000 h @ 55 °C.

Not valid for packaging material. Storage temperature for packaging material is -25 °C to +40 °C.

<sup>2)</sup> In case of applied DC voltage blocking capacitors are mandatory.

<sup>3)</sup> 

According to JESD22-A115B (MM – Machine Model), 10 negative & 10 positive pulses. According to JESD22-A114F (HBM – Human Body Model), 1 negative & 1 positive pulse. 4)

Expected lifetime according to accelerated power durability simulation and wear out models.

TSPEC is the ambient temperature of the PCB at component position. Specified min./max values from section 6 "characteristics" for maximum input power 26dBm are valid for temperature up to 75°C.

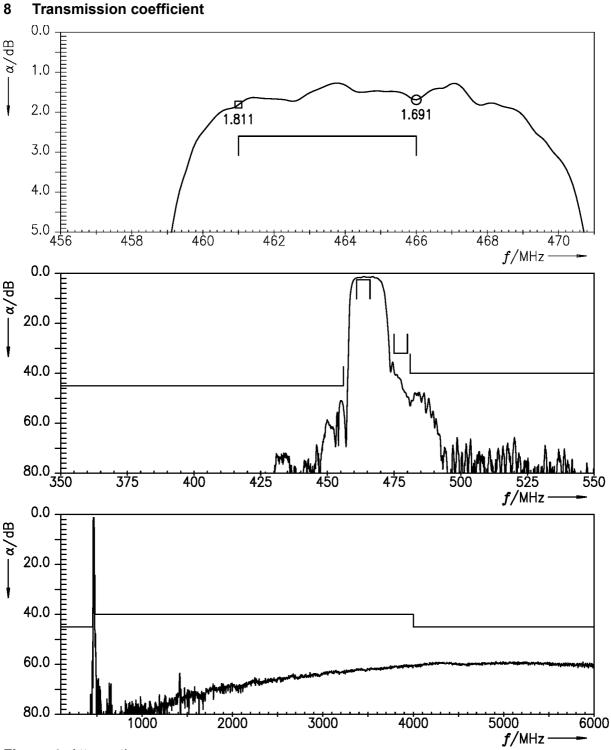
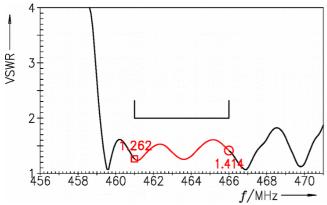


Figure 4: Attenuation.

### 9 Reflection coefficients



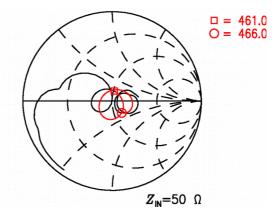
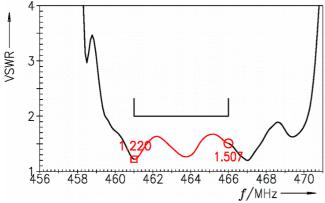


Figure 5: Reflection coefficient at input port.



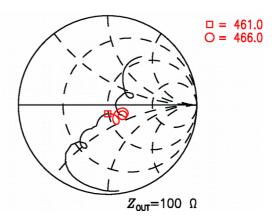


Figure 6: Reflection coefficient at output port.



# 10 Common-mode rejection ratio

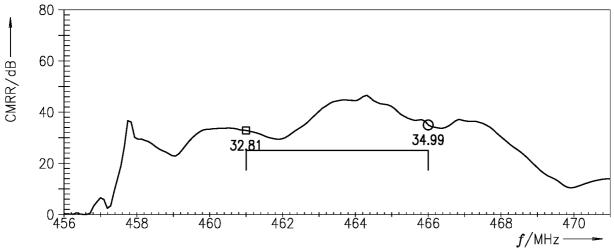
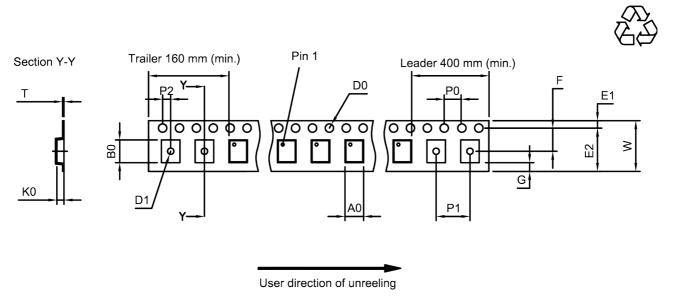


Figure 7: Common-mode rejection ratio.



### 11 Packing material

#### 11.1 Tape



**Figure 8:** Drawing of tape (first-angle projection) for illustration only and not to scale. The valid tape dimensions are listed in Table 1.

A <sub>0</sub>	1.8±0.05 mm	_	E <sub>2</sub>	6.25 mm (min.)	_	P <sub>1</sub>	4.0±0.1 mm
B <sub>0</sub>	2.25±0.05 mm		F	3.5±0.05 mm	_	$P_2$	2.0±0.05 mm
D <sub>0</sub>	1.5+0.1/-0 mm	_	G	0.75 mm (min.)	_	Т	0.25±0.03 mm
D <sub>1</sub>	1.0 mm (min.)		K <sub>0</sub>	0.6±0.05 mm		W	8.0+0.3/-0.1 mm
E <sub>1</sub>	1.75±0.1 mm	- <del>-</del>	P <sub>0</sub>	4.0±0.1 mm	·		

Table 1: Tape dimensions.

**Europe GmbH** 

#### 11.2 Reel with diameter of 180 mm

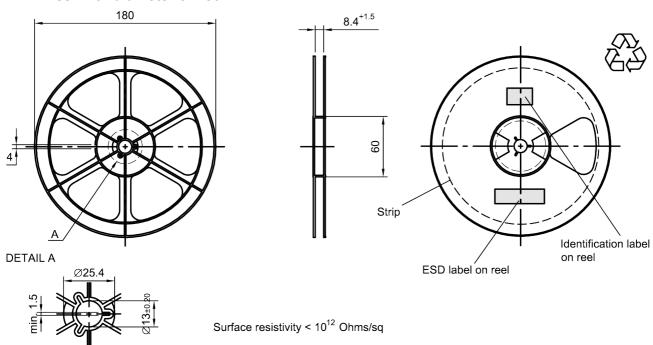


Figure 9: Drawing of reel (first-angle projection) with diameter of 180 mm.

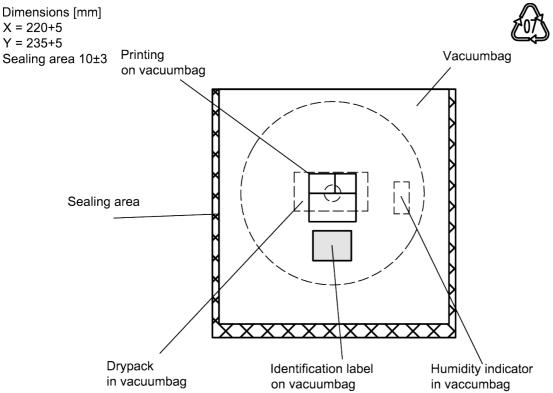


Figure 10: Drawing of moisture barrier bag (MBB) for reel with diameter of 180 mm.

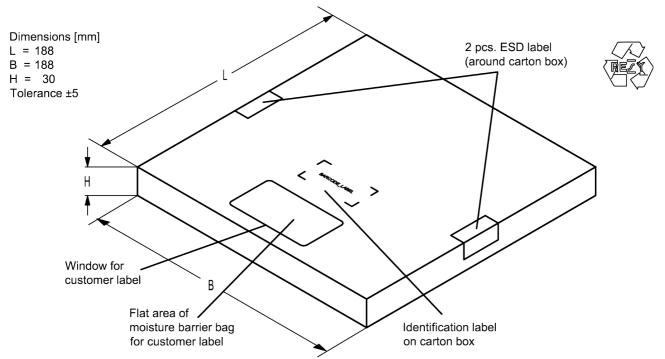


Figure 11: Drawing of folding box for reel with diameter of 180 mm.



# Europe GmbH

#### 12 Marking

Products are marked with product type number and lot number encoded according to Table 2:

### ■ Type number:

The 4 digit type number of the ordering code, e.g., B3xxxxB**1234**xxxx, is encoded by a special BASE32 code into a 3 digit marking.

Example of decoding type number marking on device in decimal code.

16J => 1234 1 x  $32^2$  + 6 x  $32^1$  + 18 (=J) x  $32^0$  = 1234

The BASE32 code for product type B8372 is 85M.

#### ■ Lot number:

The last 5 digits of the lot number, e.g., are encoded based on a special BASE47 code into a 3 digit marking.

Example of decoding lot number marking on device in decimal code.

5UY => 12345 5  $\times$  47<sup>2</sup> + 27 (=U)  $\times$  47<sup>1</sup> + 31 (=Y)  $\times$  47<sup>0</sup> = 12345

Adopted BASE32 code for type number				
Decimal	Base32	Decimal	Base32	
value	code	value	code	
0	0	16	G	
1	1	17	Н	
2	2	18	J	
3	3	19	K	
4	4	20	М	
5	5	21	N	
6	6	22	Р	
7	7	23	Q	
8	8	24	R	
9	9	25	S	
10	Α	26	Т	
11	В	27	V	
12	С	28	W	
13	D	29	Х	
14	E	30	Y	
15	F	31	Z	

Adopted DACE 47 and for let number				
Adopted BASE47 code for lot number				
Decimal	Base47	Decimal	Base47	
value	code	value	code	
0	0	24	R	
1	1	25	S	
2	2	26	T	
3	3	27	U	
4	4	28	V	
5	5	29	W	
6	6	30	X	
7	7	31	Y	
8	8	32	Z	
9	9	33	b	
10	Α	34	d	
11	В	35	f	
12	С	36	h	
13	D	37	n	
14	E	38	r	
15	F	39	t	
16	G	40	V	
17	Н	41	\	
18	J	42	?	
19	K	43	{	
20	L	44	}	
21	M	45	<	
22	N	46	>	
23	Р			

**Table 2:** Lists for encoding and decoding of marking.

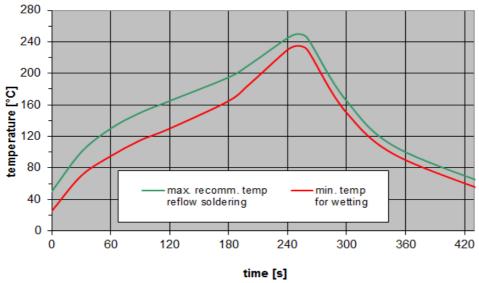


### 13 Soldering profile

The recommended soldering process is in accordance with IEC  $60068-2-58-3^{rd}$  edit and IPC/JEDEC J-STD-020B.

ramp rate	≤ 3 K/s
preheat	125 °C to 220 °C, 150 s to 210 s, 0.4 K/s to 1.0 K/s
T > 220 °C	30 s to 70 s
T > 230 °C	min. 10 s
T > 245 °C	max. 20 s
<i>T</i> ≥ 255 °C	-
peak temperature $T_{peak}$	250 °C +0/-5 °C
wetting temperature $T_{min}$	230 °C +5/-0 °C for 10 s ± 1 s
cooling rate	≤ 3 K/s
soldering temperature <i>T</i>	measured at solder pads

**Table 3:** Characteristics of recommended soldering profile for lead-free solder (Sn95.5Ag3.8Cu0.7).



**Figure 12:** Recommended reflow profile for convection and infrared soldering – lead-free solder.



#### 14 Annotations

#### 14.1 RoHS compatibility

ROHS-compatible means that products are compatible with the requirements according to Art. 4 (substance restrictions) of Directive 2011/65/EU of the European Parliament and of the Council of June 8th, 2011, on the restriction of the use of certain hazardous substances in electrical and electronic equipment ("Directive") with due regard to the application of exemptions as per Annex III of the Directive in certain cases.

#### 14.2 Scattering parameters (S-parameters)

The pin/port assignment is available in the headers of the S-parameter files. Please contact your local RF360 sales office.

# 14.3 Ordering codes and packing units

Ordering code	Packing unit
B39461B8372P810	5000 pcs

Table 4: Ordering codes and packing units.



#### 15 Cautions and warnings

#### 15.1 Display of ordering codes for RF360 products

The ordering code for one and the same product can be represented differently in data sheets, data books, other publications and the website of RF360, or in order-related documents such as shipping notes, order confirmations and product labels. The varying representations of the ordering codes are due to different processes employed and do not affect the specifications of the respective products. Detailed information can be found on the Internet under <a href="https://rffe.gualcomm.com/">https://rffe.gualcomm.com/</a>.

#### 15.2 Material information

Due to technical requirements components may contain dangerous substances. For information on the type in question please also contact one of our sales offices.

For information on recycling of tapes and reels please contact one of our sales offices.

#### 15.3 Moldability

Before using in overmolding environment, please contact your local RF360 sales office.

#### 15.4 Package information

#### Landing area

The printed circuit board (PCB) land pattern (landing area) shown is based on RF360 internal development and empirical data and illustrated for example purposes, only. As customers' SMD assembly processes may have a plenty of variants and influence factors which are not under control or knowledge of RF360, additional careful process development on customer side is necessary and strongly recommended in order to achieve best soldering results tailored to the particular customer needs.

#### **Dimensions**

Unless otherwise specified all dimensions are understood using unit millimeter (mm).

#### **Projection method**

Unless otherwise specified first-angle projection is applied.



#### 16 Important notes

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